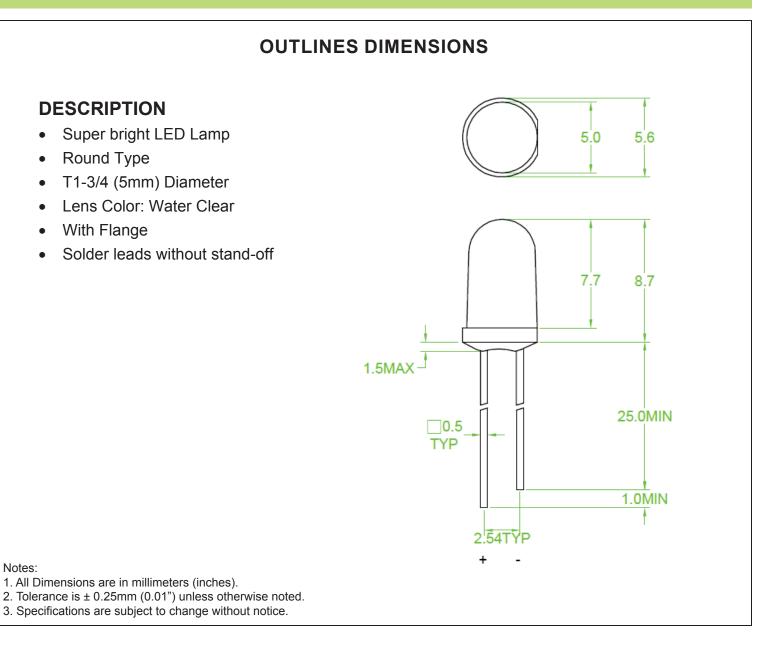


SPECIFICATIONS



Part Number	Chip Material	Color of Emission	Lens Type	Viewing Angle
CL50O4C-12D	InGaAIP	Orange	Water Clear	12°



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CL50O4C-12D



ABSOLUTE MAXIMUM RATINGS

Parameter Symbol Max Rating Unit 120 **Power Dissipation** PD mW 90 **Pulse Current Forward Current** IFP mA 50 **Continuous Forward Current** IF mΑ V **Reverse Voltage** VR 5 **Operating Temperature Range** TOPR -40~+85 °C Storage Temperature Range °C Tstg -40~+110 IFP = Pulse Width ≤ 10 ms, Duty Ratio ≤1/10. Soldering Condition: 260 °C/ 5sec

OPTICAL-ELECTRICAL CHARACTERISTICS

Value Parameter Test Condition Unit Symbol Min Тур Max 21000 32000 _ Luminous Intensity Iv I_F = 20mA mcd Forward Voltage I⊧ = 20mA 2.2 2.6 V VF 10 $V_R = 5V$ _ Reverse Leakage Current IR _ μA 12 $2\theta 1/2$ I_F = 20mA _ Viewing Angle _ deg 605 I_F = 20mA _ _ **Dominant Wavelength** λD nm

*Tolerance of viewing angle: -10 / +5 deg.



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(TA=25°C)

(TA=25°C)



OPTICAL CHARACTERISTIC CURVES

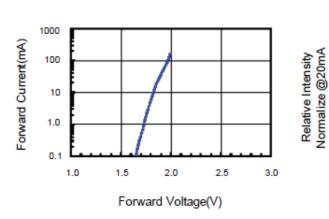


Fig.1 Forward current vs. Forward Voltage

Fig.3 Forward Voltage vs. Temperature

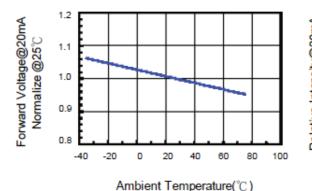
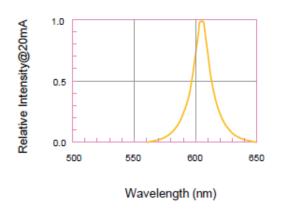
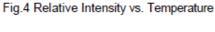


Fig.5 Relative Intensity vs. Wavelength



RoH

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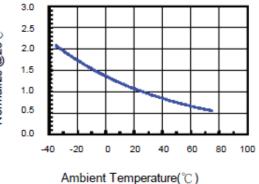


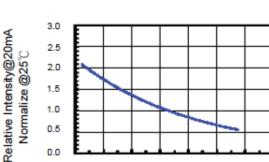
10

Forward Current(mA)

100

1000







3.0

2.5

2.0 1.5

1.0

0.5

0.0

1.0



SOLDERING CONDITIONS – LAMP TYPE LED

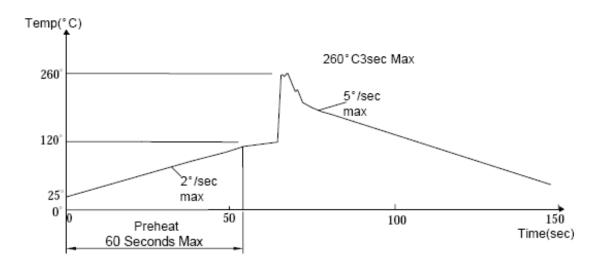
SOLDERING CONDITION (Pb-Free)

1. Iron:

Soldering Iron: 30W Max Temperature 350°C Max Soldering Time: 3 Seconds Max (One Time) Distance: 2mm Min (From solder joint to body)

2. Wave Soldering Profile

Dip Soldering Preheat: 120°C Max Preheat time: 60 seconds Max Ramp-up 2°C/sec (Max) Ramp-Down: -5°C/sec (Max) Solder Bath: 260°C Max Dipping Time: 3 seconds Max Distance: 2mm Min (from solder joint to body)





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